ShinDengen

D3CE15ST

Schottky Barrier Diodes
150V, 3A

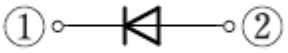
Feature

- Ultra-small SMD
- High Voltage
- Ultra thin PKG
- Tj=175°C
- Ultra low I_R
- Based on AEC-Q101
- Pb free terminal
- RoHS:Yes

OUTLINE

Package (House Name): CE
Package (JEITA Code): SC-110B

Equivalent circuit



Absolute Maximum Ratings (unless otherwise specified : Tl=25°C)

Item	Symbol	Conditions	Ratings	Unit
Storage temperrature	Tstg		-55 to 175	°C
Junction temperature	Tj		-55 to 175	°C
Repetitive peak reverse voltage	V_{RRM}		150	V
Average forward current	I_F(AV)	50Hz sine wave, Resistance load, Tl=136°C	3	A
Average forward current	I_F(AV)	50Hz sine wave, Resistance load, On glass-epoxy substrate, Ta=25°C ※	1.7	A
Average forward current	I_F(AV)	50Hz sine wave, Resistance load, On glass-epoxy substrate, Ta=25°C ※	1.2	A
Surge forward current	I_{FSM}	50Hz sine wave, Non-repetitive, 1cycle, Peak value, Tj=25°C	80	A

※ ：See the original Specifications

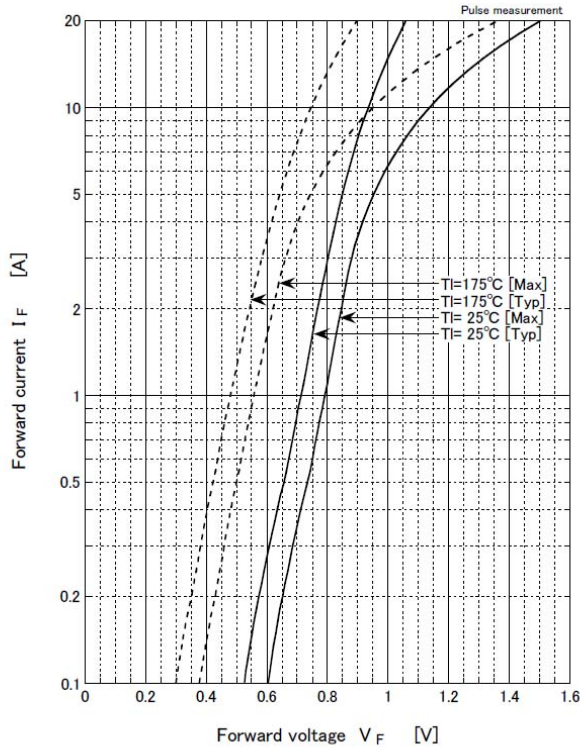
Electrical Characteristics (unless otherwise specified : Tl=25°C)

Item	Symbol	Conditions	Ratings			Unit
			MIN	TYP	MAX	
Forward voltage	V_F	IF=3A, Pulse measurement			0.88	V
Reverse current	I_R	VR=150V, Pulse measurement			0.008	mA
Total capacitance	Ct	f=1MHz, VR=10V		52		pF
Thermal resistance	Rth(j-l)	Junction to lead			15	°C/W
Thermal resistance	Rth(j-a)	Junction to ambient, On glass-epoxy substrate ※			115	°C/W
Thermal resistance	Rth(j-a)	Junction to ambient, On glass-epoxy substrate ※			172	°C/W

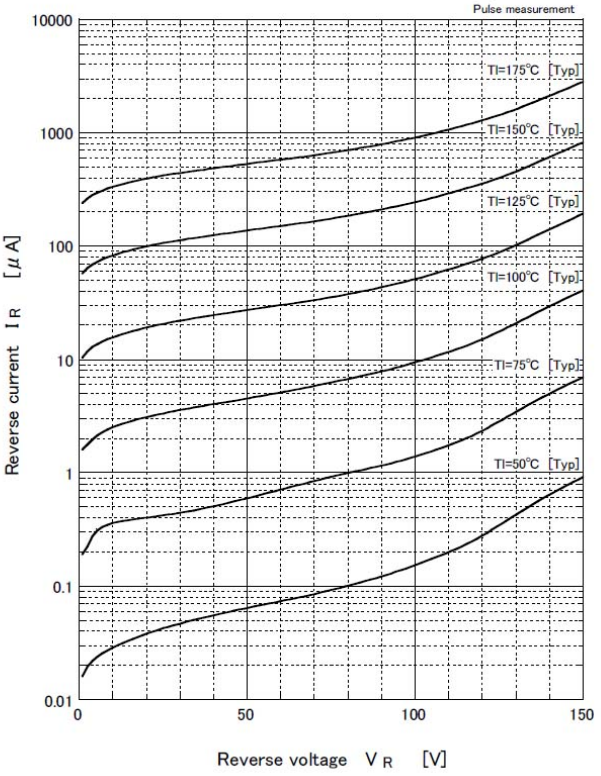
※ ：See the original Specifications

CHARACTERISTIC DIAGRAMS

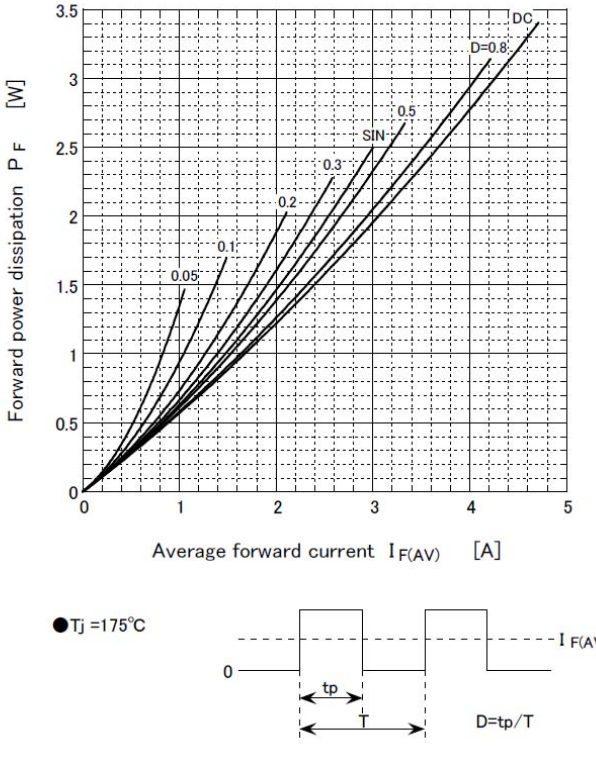
Forward voltage



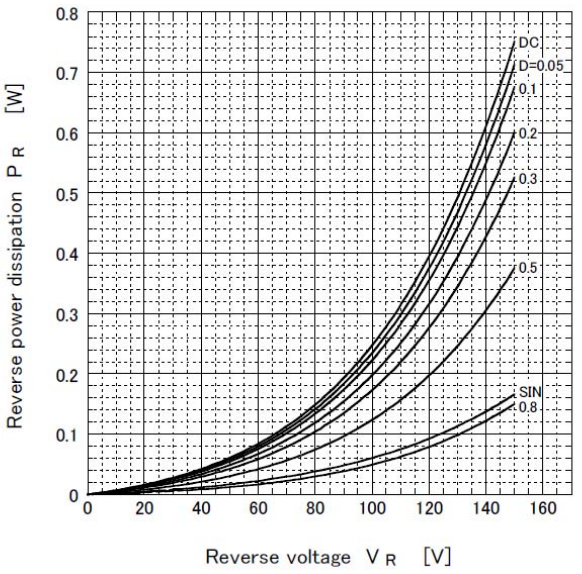
Reverse current

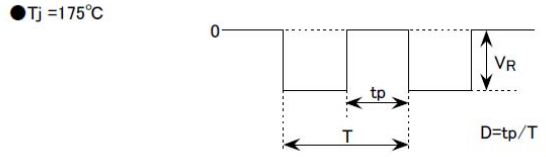


Forward power dissipation

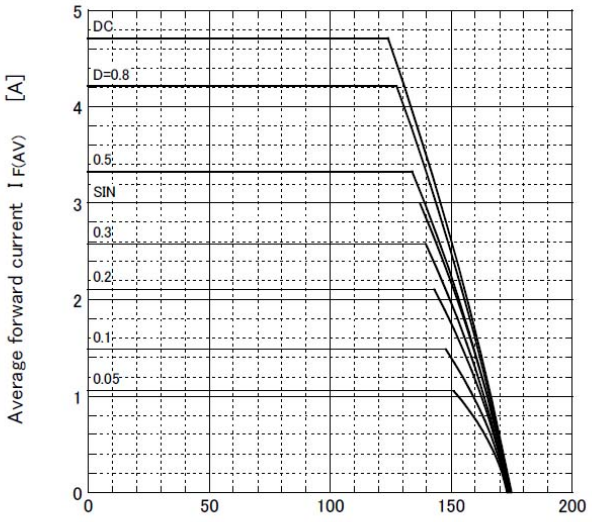


Reverse power dissipation

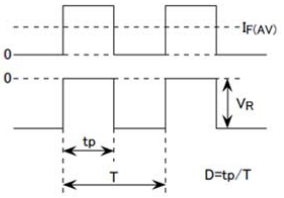




Derating curve



●V_R = 75V
R-load
Free in air



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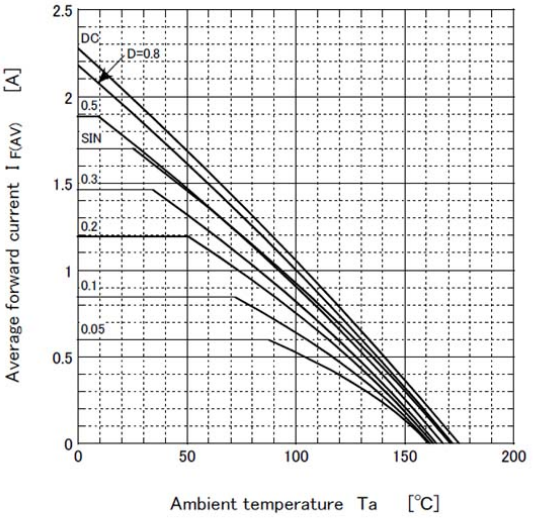
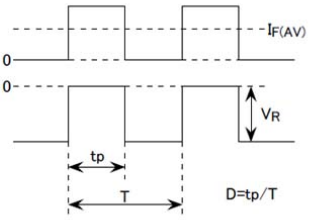


●V_R = 75V
R-load
Free in air

●Substrate detail

Type	Glass-epoxy
Size	2 inch²
Thickness	1mm
Conductor thickness	35μm
Pattern area	160mm²



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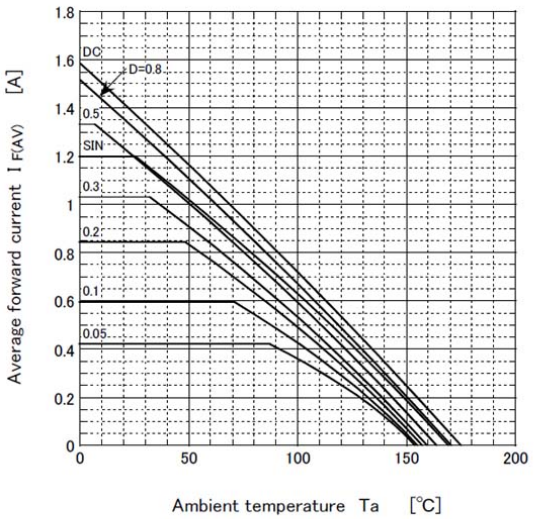

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Type	Glass-epoxy
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Thickness	1mm
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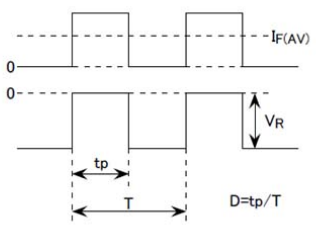
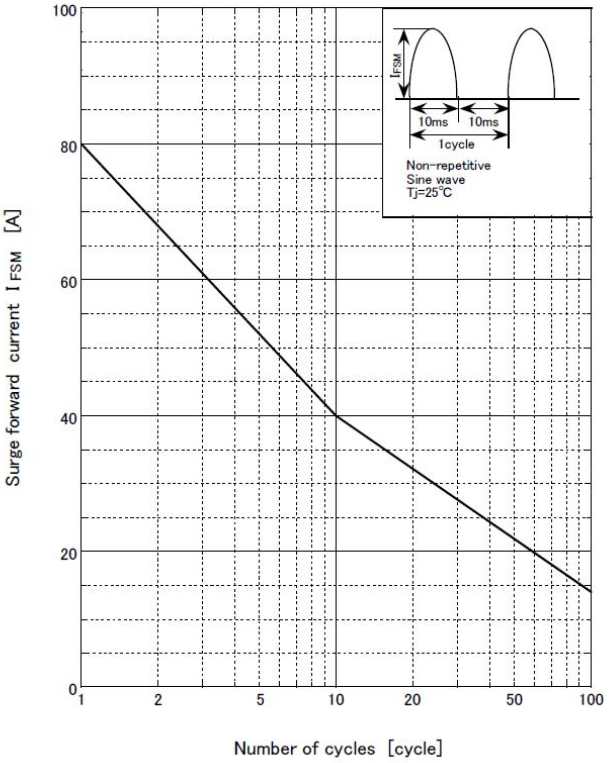
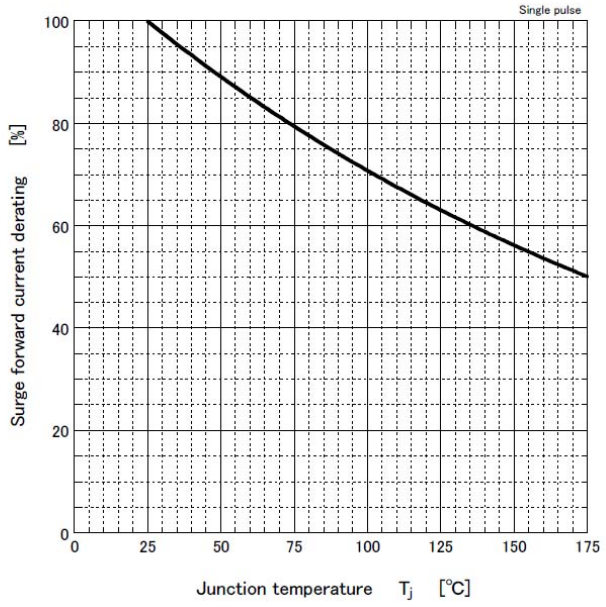
Pattern area	32mm²

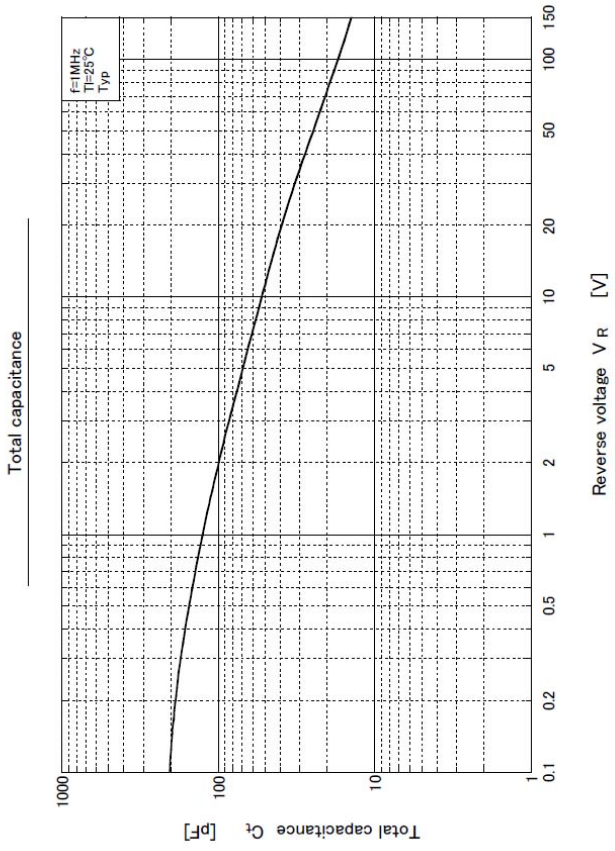


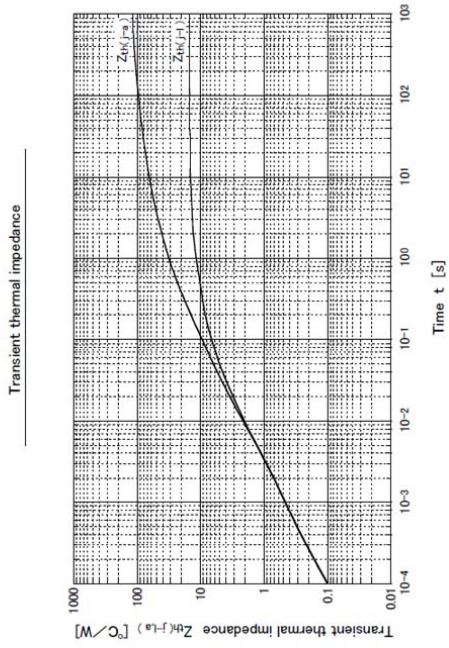
Surge forward current capability



Surge forward current derating
vs Junction temperature







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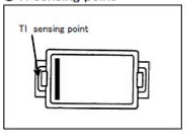
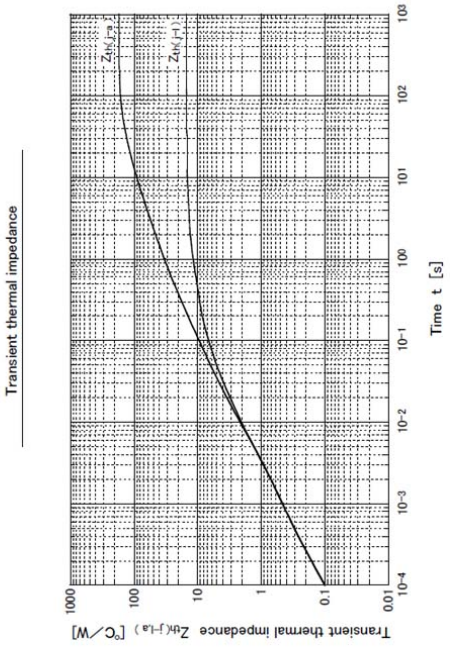
●TI sensing point





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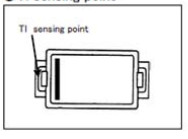


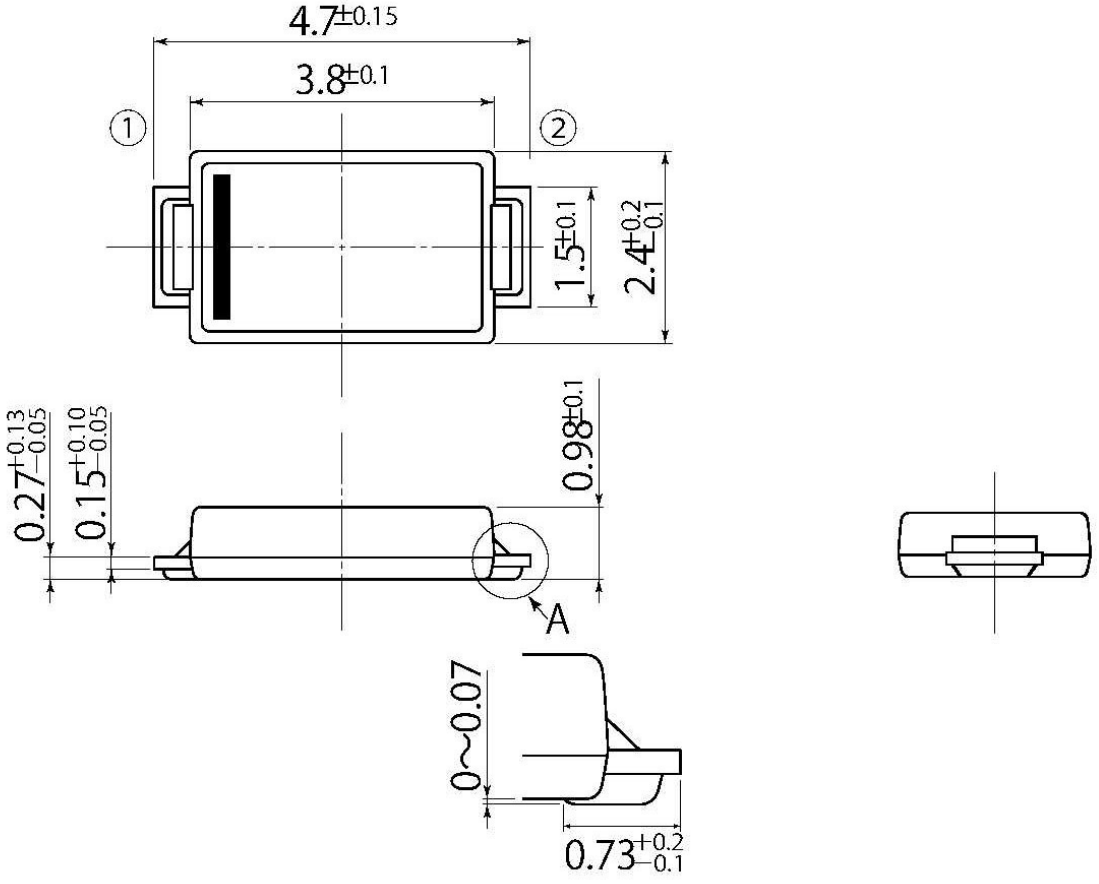
Outline Dimensions

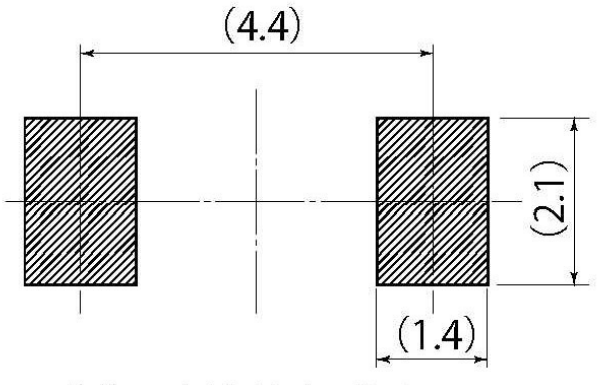
unit:mm

scale: 10/1

B5

JEDEC Code	–
JEITA Code	SC-110B
House Name	CE





Referential Soldering Pad

・Optimize soldering pad to the board design and soldering condition.

Notes

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